

L Number	Hits	Search Text	DB	Time stamp
-	1869	silicon adj nitride and sputtering and nitrogen and argon and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/29 22:03
-	575	silicon adj nitride and sputtering and nitrogen and argon and volume and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/29 22:04